

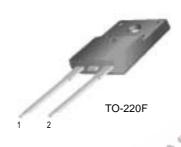
## **FFPF06F150S**

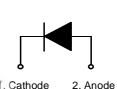
### **Features**

- · High voltage and high reliability
- High speed switching
- · Low forward voltage

## **Applications**

Suitable for damper diode in horizontal deflection circuits





## **DAMPER DIODE**

### Absolute Maximum Ratings T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	1500	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 125°C	6	Α
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	60	А
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	- 65 to +150	°C

### **Thermal Characteristics**

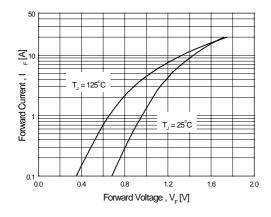
Symbol	Parameter	Value	Units
$R_{\theta,JC}$	Maximum Thermal Resistance, Junction to Case	4.0	°C/W

## Electrical Characteristics $\tau_{\text{C}}$ =25 °C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V <sub>FM</sub> *	Maximum Instantaneous Forward Voltage					V
	I <sub>F</sub> = 6A	T <sub>C</sub> = 25 °C T <sub>C</sub> = 125 °C	-	-	1.6	
	I <sub>F</sub> = 6A	T <sub>C</sub> = 125 °C	-	-	1.4	
I <sub>RM</sub> *	Maximum Instantaneous Reverse Current					μΑ
	@ rated V <sub>R</sub>	T <sub>C</sub> = 25 °C T <sub>C</sub> = 125 °C	-	-	7	
		T <sub>C</sub> = 125 °C	-	-	60	
t <sub>rr</sub>	Maximum Reverse Recovery Time		-	-	170	ns
	$(I_F = 1A, di/dt = 50A/\mu s)$					
t <sub>fr</sub>	Maximum Forward Recovery Time		-	-	350	ns
	$(I_F = 6.5A, di/dt = 50A/\mu s)$					
$V_{FRM}$	Maximum Forward Recovery Voltage		-	-	17	V

 $<sup>^{\</sup>star}$  Pulse Test: Pulse Width=300  $\mu s,$  Duty Cycle=2%

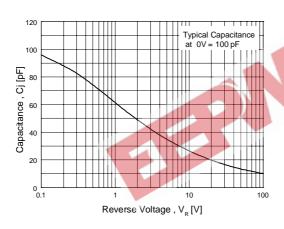
## **Typical Characteristics**



No.001 0 300 600 900 1200 1500 Reverse Voltage , V<sub>R</sub> [V]

Figure 1. Typical Forward Voltage Drop vs. Forward Current

Figure 2. Typical Reverse Current vs. Reverse Voltage



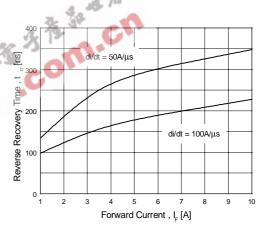
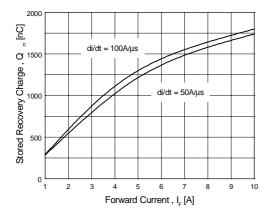


Figure 3. Typical Junction Capacitance

Figure 4. Typical Reverse Recovery Time vs. Forward Current



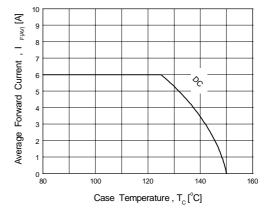


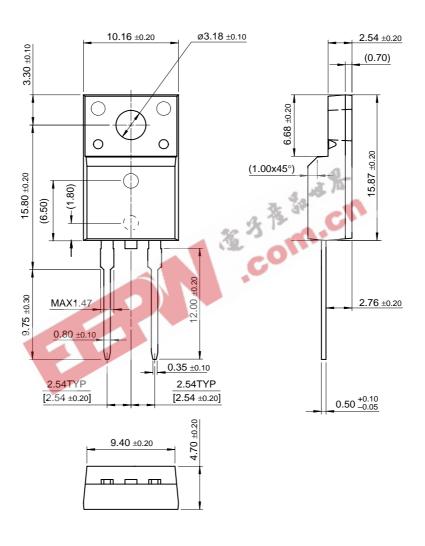
Figure 5. Typical Stored Charge vs. Forward Current

Figure 6. Forward Current Derating Curve

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# **Package Dimensions**

# TO-220F 2L



Dimensions in Millimeters

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DOME™	ISOPLANAR™	SuperSOT™-3	
E <sup>2</sup> CMOS™	MICROWIRE™	SuperSOT™-6	
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